



DGD21844M

HALF-BRIDGE GATE DRIVER IN SO-14

Description

The DGD21844M is a high voltage and high speed gate driver capable of driving N-Channel MOSFETs and IGBTs in a half-bridge configuration. High voltage processing techniques enable the DGD21844M's high-side to switch to 600V in a bootstrap operation.

The DGD21844M logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) for easy interfacing with controlling devices. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction. Programmable deadtime by an external resistor provides more system level flexibility.

The DGD21844M is offered in the SO-14 package and the device's operating temperature extends from -40° C to $+125^{\circ}$ C.

но

VB

Vs

сом

LO

Typical Configuration

DGD21844M

Applications

- DC-DC converters
- DC-AC inverters
- AC-DC power supplies
- Motor controls

V_{CC} o-

IN C

SD* o

Class-D power amplifiers

Features

- Floating High-Side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in Half Bridge Configuration
- 1.9A Source / 2.3A Sink Output Current Capability
- Outputs Tolerant to Negative Transients
- Programmable Deadtime to Protect MOSFETs
- Wide Low-Side Gate Driver and Logic Supply: 10V to 20V
- Wide Logic Supply Voltage Offset Voltage: -5V to 5V
- Logic Input (IN and SD*) 3.3V Capability
- Schmitt Triggered Logic Inputs with Internal Pull Down
- Undervoltage Lockout for High- and Low-Side Drivers
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: SO-14 (Type TH)
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ⁽²⁾
- Weight: 0.142 grams (Approximate)



Ordering Information (Note 4)

Vcd

IN

SD*

DT

Vss

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
DGD21844MS14-13	DGD21844M	13	16	2,500

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

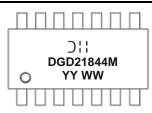
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Up to 600V

+⊥ ⊕

TO LOAD

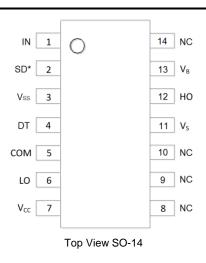
Marking Information



)'! = Manufacturer's Marking DGD21844M = Product Type Marking Code YY = Year (ex: 22 = 2022) WW = Week (01 to 53)



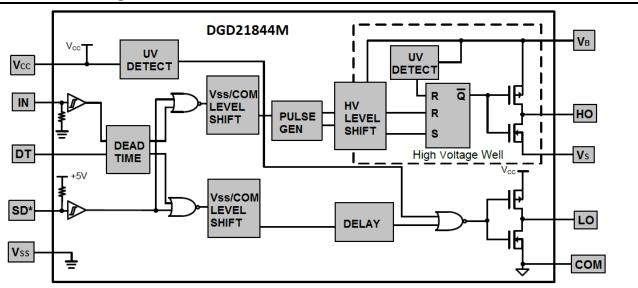
Pin Diagrams



Pin Descriptions

Pin Number	Pin Name	Function
1	IN	Logic input for high-side and low-side gate driver outputs (HO and LO), in phase with HO (referenced to V _{SS})
2	SD*	Logic input for shutdown (referenced to V _{SS}), enabled low
3	Vss	Logic ground
4	DT	Programmable Deadtime lead, referenced to V _{SS}
5	COM	Low-side return
6	LO	Low-side gate drive output
7	V _{CC}	Low-side and logic fixed supply
8, 9, 10, 14	NC	No connection (no internal connection)
11	Vs	High-side floating supply return
12	HO	High-side gate drive output
13	VB	High-side floating supply

Functional Block Diagram





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	VB	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V _B -24 to V _B +0.3	V
High-Side Floating Output Voltage	V _{HO}	V _S -0.3 to V _B +0.3	V
Offset Supply Voltage Transient	dV _S / dt	50	V/ns
Programmable Dead Time Pin Voltage	V _{DT}	V _{SS} -0.3 to V _{CC} +0.3	V
Logic and Low-Side Fixed Supply Voltage	V _{CC}	-0.3 to +24	V
Low-Side Output Voltage	VLO	-0.3 to V _{CC} +0.3	V
Logic Supply Offset Voltage	V _{SS}	V _{CC} -24 to V _{CC} +0.3	V
Logic Input Voltage (IN and SD*)	V _{IN}	V _{SS} -0.3 to V _{CC} +0.3	V

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	1.0	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	120	°C/W
Operating Temperature	T_J	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T _{STG}	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	VB	Vs + 10	Vs + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High Side Floating Output Voltage	V _{HO}	Vs	VB	V
Logic and Low Side Fixed Supply Voltage	Vcc	10	20	V
Low Side Output Voltage	V _{LO}	0	V _{CC}	V
Logic Input Voltage (IN and SD*)	V _{IN}	V _{SS}	5	V
Programmable Dead Time Pin Voltage	V _{DT}	Vss	Vcc	V
Logic Ground	V _{SS}	-5	5	V
Ambient Temperature	T _A	-40	+125	°C

Note: 6. Logic operation for $V_S = -5V$ to +600V.



			Τ	1	1	
Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage for HO & Logic "0" for LO	VIH	2.5			V	$V_{CC} = 10V$ to 20V
Logic "0" Input Voltage for HO & Logic "1" for LO	VIL	_		0.8	V	V_{CC} = 10V to 20V
SD* Input Positive Going Threshold	V _{SDTH+}	2.5	_	_	V	V_{CC} = 10V to 20V
SD* Input Negative Going Threshold	V _{SDTH-}	_	_	0.8	V	V_{CC} = 10V to 20V
High Level Output Voltage, V _{BIAS} - V _O	V _{OH}	_	_	1.4	V	$I_{O} = 0mA$
Low Level Output Voltage, V _O	V _{OL}			0.2	V	$I_0 = 20 \text{mA}$
Offset Supply Leakage Current	I _{LK}	_	_	50	μA	$V_{B} = V_{S} = 600V$
Quiescent V _{BS} Supply Current	I _{BSQ}	20	60	150	μA	$V_{IN} = 0V \text{ or } 5V$
Quiescent V _{CC} Supply Current	Iccq	0.4	1.0	1.8	mA	$V_{IN} = 0V \text{ or } 5V$
Logic "1" Input Bias Current	I _{IN+}	_	25	60	μA	IN = 5V, SD* = 0V
Logic "0" Input Bias Current	I _{IN-}	_	_	1.0	μA	IN = 0V, SD* = 5V
V _{BS} Supply Undervoltage Positive Going Threshold	V _{BSUV+}	8.0	8.9	9.8	V	_
V _{BS} Supply Undervoltage Negative Going Threshold	V _{BSUV-}	7.4	8.2	9.0	V	_
V _{CC} Supply Undervoltage Positive Going Threshold	V _{CCUV+}	8.0	8.9	9.8	V	_
V _{CC} Supply Undervoltage Negative Going Threshold	V _{CCUV-}	7.4	8.2	9.0	V	_
Output-High Short-Circuit Pulsed Current	I _{O+}	1.4	1.9	_	А	V _O = 0V, PW ≤ 10µs
Output-Low Short-Circuit Pulsed Current	I _{O-}	1.7	2.3	_	А	V _O = 15V, PW ≤ 10µs

DC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, V_{SS} = COM, @T_A = +25°C, unless otherwise specified.) (Note 7)

Note: 7. The V_{IN} and I_{IN} parameters are referenced to V_{SS} and are applicable to the two logic input pins: IN and SD*. The V_O and I_O parameters are referenced to COM and are applicable to the respective output pins: HO and LO.

AC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, V_{SS} = COM, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	ton		680	900	ns	$V_{\rm S} = 0V$
Turn-Off Propagation Delay	toff		270	400	ns	$V_{\rm S} = 0V \text{ or } 600V$
Shut-Down Propagation Delay	t _{SD}	_	180	270	ns	_
Delay Matching, HO & LO Turn-On	t _{DMON}		_	90	ns	_
Delay Matching, HO & LO Turn-Off	t DMOFF	_	_	40	ns	_
Turn-On Rise Time	t _R	_	40	60	ns	$V_{\rm S} = 0V$
Turn-Off Fall Time	tF	_	20	35	ns	$V_{\rm S} = 0V$
		280	400	520	ns	$R_{DT} = 0\Omega$
Deadtime: t _{DT LO-HO} & t _{DT HO-LO}	t _{DT}	4	5	6	μs	$R_{DT} = 200 k\Omega$
		_	0	50	ns	$R_{DT} = 0\Omega$
Deatime Matching = t _{DT LO-HO} - t _{DT HO-LO}	t _{MDT}	_	0	600	ns	R _{DT} = 200kΩ



Timing Waveforms

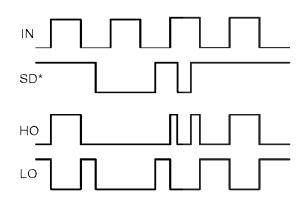


Figure 1. Input / Output Timing Diagram

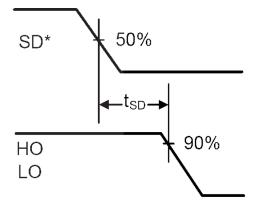
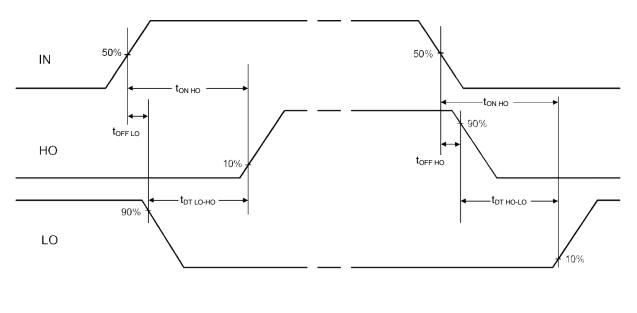
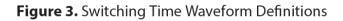


Figure 2. Shutdown Waveform Definitions



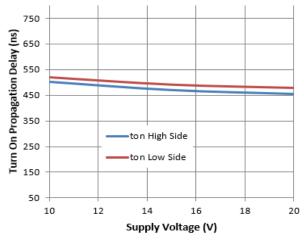
 $\begin{array}{l} \text{Deadtime } t_{\text{DT }\text{LO-HO}} = t_{\text{ON }\text{HO}} + t_{\text{OFF }\text{LO}} \\ t_{\text{DT }\text{HO-LO}} = t_{\text{ON }\text{LO}} - t_{\text{OFF }\text{HO}} \\ \text{Deadtime matching} \\ t_{\text{MDT}} = t_{\text{DT }\text{LO-HO}} - t_{\text{DT }\text{HO-LO}} \end{array}$

Delay matching t_{DM OFF} = t_{OFF LO} - t_{OFFT HO}





Typical Performance Characteristics ($V_{CC} = 15V$, $@T_A = +25^{\circ}C$, unless otherwise specified.)



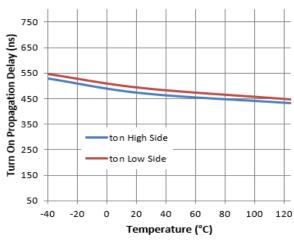


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

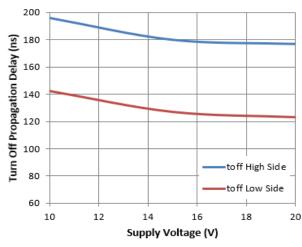


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

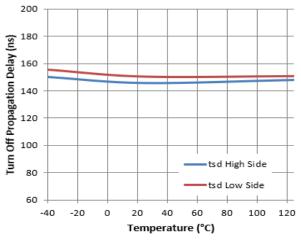


Figure 8. SD Propagation Delay vs. Temperature

Figure 5. Turn-on Propagation Delay vs. Temperature

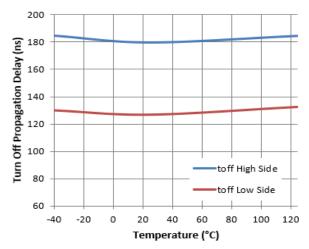


Figure 7. Turn-off Propagation Delay vs. Temperature

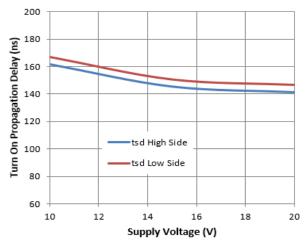
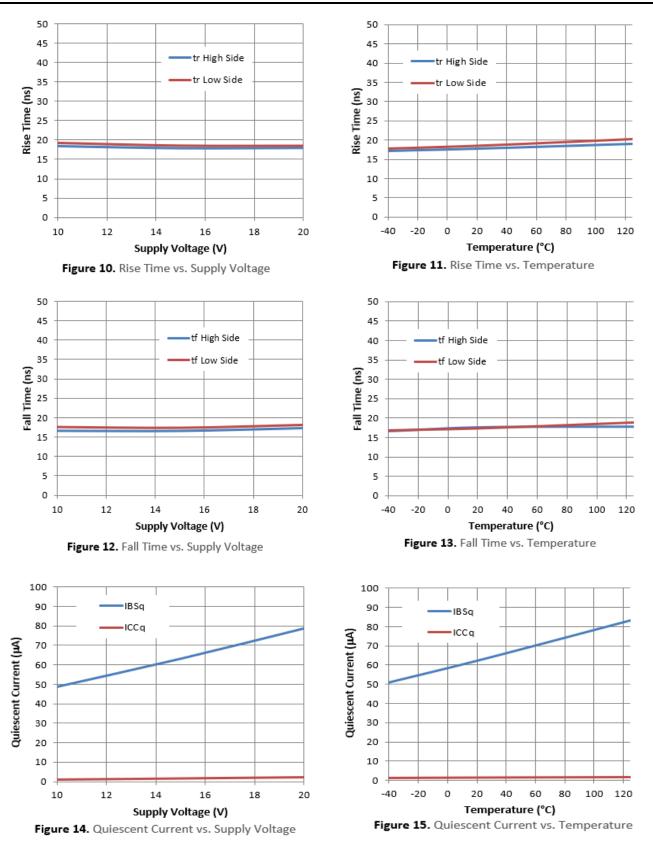
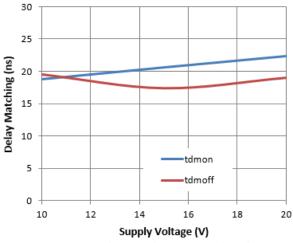


Figure 9. SD Propagation Delay vs. Supply Voltage

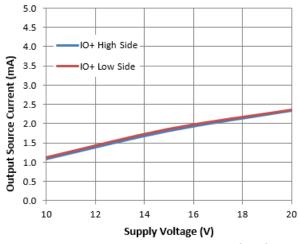














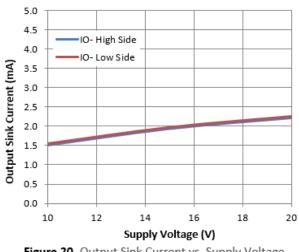


Figure 20. Output Sink Current vs. Supply Voltage

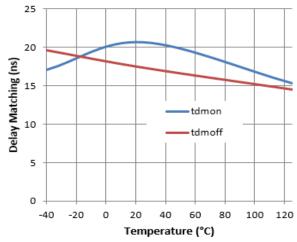
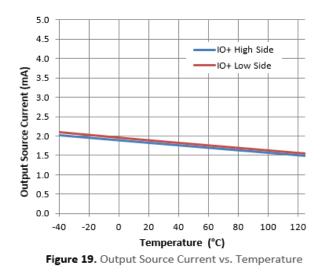
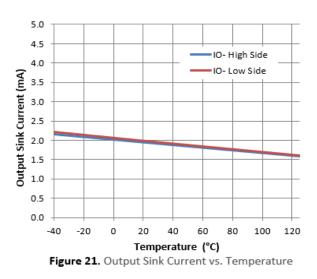
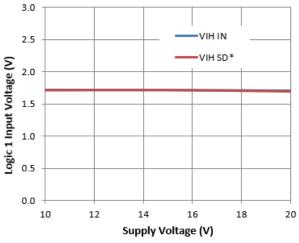


Figure 17. Delay Matching vs. Temperature

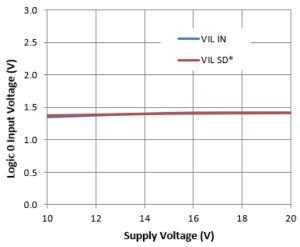




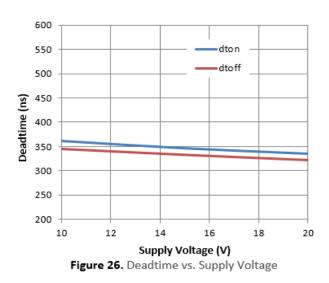












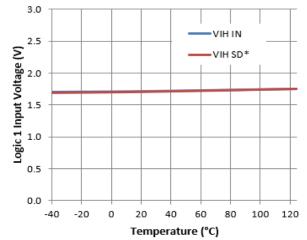


Figure 23. Logic 1 Input Voltage vs. Temperature

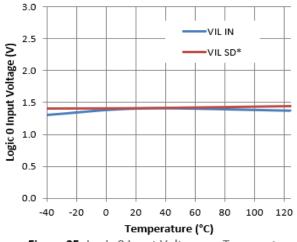
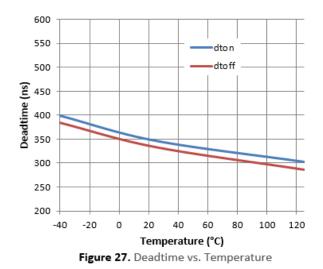
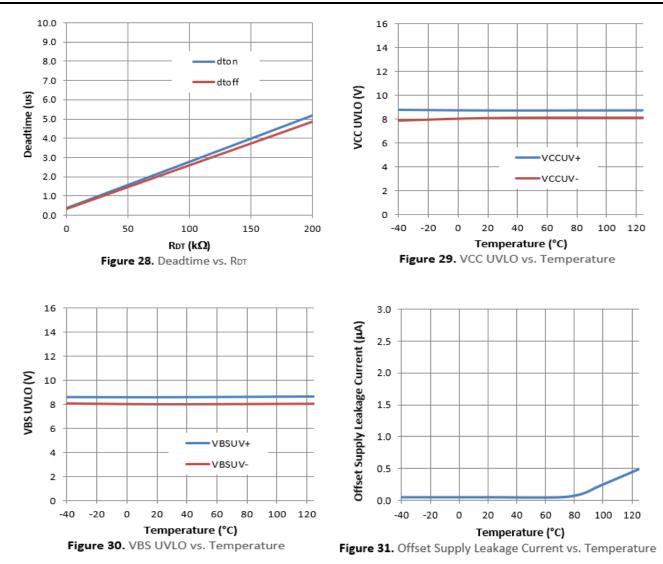


Figure 25. Logic 0 Input Voltage vs. Temperature



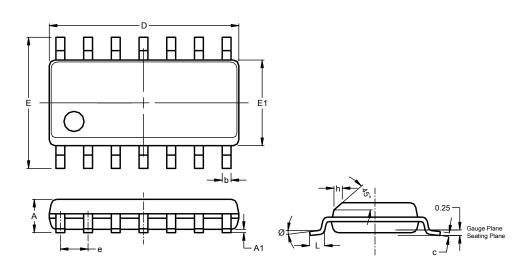






Package Outline Dimensions

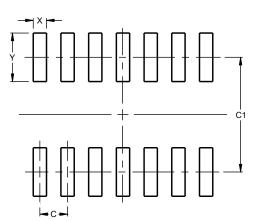
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-14 (Type TH)				
Dim	Min	Max	Тур	
Α	1.55	1.73		
A1	0.10	0.25		
b	0.35	0.51		
С	0.190	0.248		
D	8.56	8.74	8.61	
E	5.84	6.20	6.00	
E1	3.81	3.99	3.94	
е			1.27	
h			0.33	
L	0.41	0.89		
Ø	0°	8°		
All C	Dimensi	ons in i	mm	

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-14	(Type	TH)	
00-1-1		,	

SO-14 (Type TH)

Dimensions	Value (in mm)
С	1.27
C1	5.20
Х	0.60
Y	2.20



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